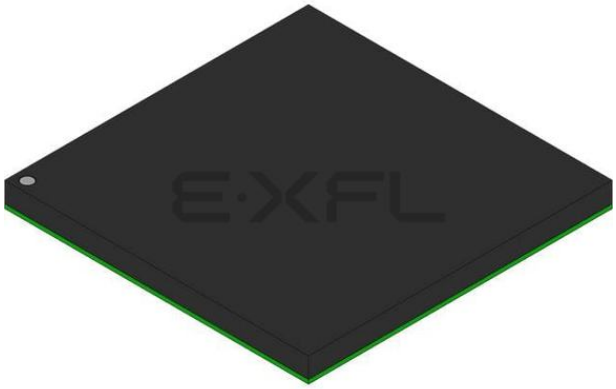

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Understanding Embedded - Microprocessors

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

Applications of Embedded - Microprocessors

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details	
Product Status	Active
Core Processor	PowerPC G2_LE
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	400MHz
Co-Processors/DSP	Communications; RISC CPM
RAM Controllers	DRAM, SDRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	10/100Mbps (2)
SATA	-
USB	USB 2.0 (1)
Voltage - I/O	3.3V
Operating Temperature	0°C ~ 105°C (TA)
Security Features	-
Package / Case	516-BBGA
Supplier Device Package	516-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/pro/item?MUrl=&PartUrl=mpc8271zqtiea

  - Floating-point unit (FPU) supports floating-point arithmetic
  - Support for cache locking
- Low-power consumption
- Separate power supply for internal logic (1.5 V) and for I/O (3.3 V)
- Separate PLLs for G2_LE core and for the communications processor module (CPM)
  - G2_LE core and CPM can run at different frequencies for power/performance optimization
  - Internal core/bus clock multiplier that provides ratios 2:1, 2.5:1, 3:1, 3.5:1, 4:1, 4.5:1, 5:1, 5.5:1, 6:1, 7:1, 8:1
  - Internal CPM/bus clock multiplier that provides ratios 2:1, 2.5:1, 3:1, 3.5:1, 4:1, 5:1, 6:1, 8:1 ratios
- 64-bit data and 32-bit address 60x bus
  - Bus supports multiple master designs—up to two external masters
  - Supports single transfers and burst transfers
  - 64-, 32-, 16-, and 8-bit port sizes controlled by on-chip memory controller
- 60x-to-PCI bridge
  - Programmable host bridge and agent
  - 32-bit data bus, 66 MHz, 3.3 V
  - Synchronous and asynchronous 60x and PCI clock modes
  - All internal address space available to external PCI host
  - DMA for memory block transfers
    - PCI-to-60x address remapping
- System interface unit (SIU)
  - Clock synthesizer
  - Reset controller
  - Real-time clock (RTC) register
  - Periodic interrupt timer
  - Hardware bus monitor and software watchdog timer
  - IEEE 1149.1 JTAG test access port
- Eight bank memory controller
  - Glueless interface to SRAM, page mode SDRAM, DRAM, EPROM, Flash, and other user-definable peripherals
  - Byte write enables
  - 32-bit address decodes with programmable bank size
  - Three user-programmable machines, general-purpose chip-select machine, and page mode pipeline SDRAM machine
  - Byte selects for 64-bit bus width (60x)
  - Dedicated interface logic for SDRAM
- Disable CPU mode

- Integrated security engine (SEC) (MPC8272 and MPC8248 only)
  - Supports DES, 3DES, MD-5, SHA-1, AES, PKEU, RNG and RC-4 encryption algorithms in hardware
- Communications processor module (CPM)
  - Embedded 32-bit communications processor (CP) uses a RISC architecture for flexible support for communications peripherals
  - Interfaces to G2_LE core through on-chip dual-port RAM and DMA controller. (Dual-port RAM size is 16 KB plus 4 KB dedicated instruction RAM.)
  - Microcode tracing capabilities
  - Eight CPM trap registers
- Universal serial bus (USB) controller
  - Supports USB 2.0 full/low rate compatible
  - USB host mode
    - Supports control, bulk, interrupt, and isochronous data transfers
    - CRC16 generation and checking
    - NRZI encoding/decoding with bit stuffing
    - Supports both 12- and 1.5-Mbps data rates (automatic generation of preamble token and data rate configuration). Note that low-speed operation requires an external hub.
    - Flexible data buffers with multiple buffers per frame
    - Supports local loopback mode for diagnostics (12 Mbps only)
  - Supports USB slave mode
    - Four independent endpoints support control, bulk, interrupt, and isochronous data transfers
    - CRC16 generation and checking
    - CRC5 checking
    - NRZI encoding/decoding with bit stuffing
    - 12- or 1.5-Mbps data rate
    - Flexible data buffers with multiple buffers per frame
    - Automatic retransmission upon transmit error
  - Serial DMA channels for receive and transmit on all serial channels
  - Parallel I/O registers with open-drain and interrupt capability
  - Virtual DMA functionality executing memory-to-memory and memory-to-I/O transfers
  - Two fast communication controllers (FCCs) supporting the following protocols:
    - 10-/100-Mbit Ethernet/IEEE 802.3 CDMA/CS interface through media independent interface (MII)
    - Transparent
    - HDLC—up to T3 rates (clear channel)

This table lists recommended operational voltage conditions.

Table 4. Recommended Operating Conditions[1]

Rating	Symbol	Value	Unit
Core supply voltage	VDD	1.425 – 575	V
PLL supply voltage	VCCSYN	1.425 – 575	V
I/O supply voltage	VDDH	3.135 – 3.465	V
Input voltage	VIN	GND (–0.3) – 3.465	V
Junction temperature (maximum)	T_j	105[2]	°C
Ambient temperature	T_A	0–70[2]	°C

1 **Caution:** These are the recommended and tested operating conditions. Proper operation outside of these conditions is not guaranteed.

2 Note that for extended temperature parts the range is $(-40)_{T_A}$ – 105_{T_j}.

This SoC contains circuitry protecting against damage due to high static voltage or electrical fields; however, it is advised that normal precautions be taken to avoid application of any voltages higher than maximum-rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (either GND or V_{CC}).

This figure shows the undershoot and overshoot voltage of the 60x bus memory interface of the SoC. Note that in PCI mode the I/O interface is different.

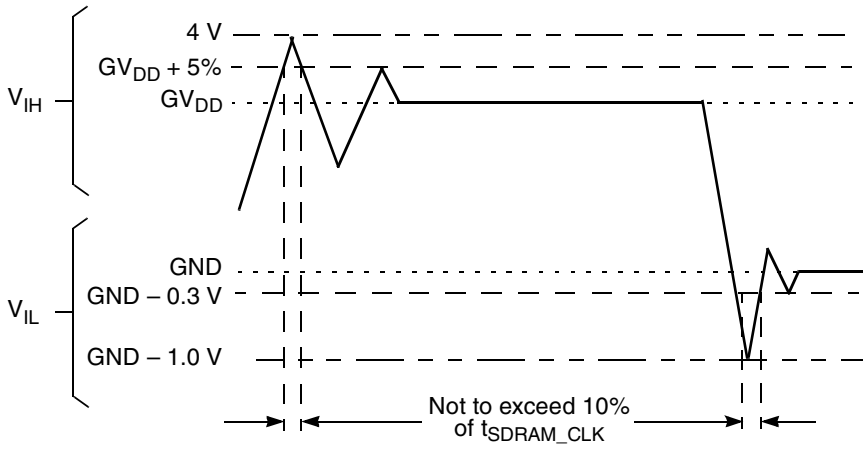


Figure 2. Overshoot/Undershoot Voltage

This table lists CPM input characteristics.

NOTE: Rise/Fall Time on CPM Input Pins

It is recommended that the rise/fall time on CPM input pins should not exceed 5 ns. This should be enforced especially on clock signals. Rise time refers to signal transitions from 10% to 90% of VCC; fall time refers to transitions from 90% to 10% of VCC.

Table 11. AC Characteristics for CPM Inputs[1]

Spec Number		Characteristic	Value (ns)							
			Setup				Hold			
Setup	Hold		66 MHz	83 MHz	100 MHz	133 MHz	66 MHz	83 MHz	100 MHz	133 MHz
sp16a	sp17a	FCC inputs—internal clock (NMSI)	6	6	6	6	0	0	0	0
sp16b	sp17b	FCC inputs—external clock (NMSI)	2.5	2.5	2.5	2.5	2	2	2	2
sp18a	sp19a	SCC/SMC/SPI/I2C inputs—internal clock (NMSI)	6	6	6	6	0	0	0	0
sp18b	sp19b	SCC/SMC/SPI/I2C inputs—external clock (NMSI)	4	4	4	4	2	2	2	2
sp20	sp21	TDM inputs/SI	3	3	3	3	2.5	2.5	2.5	2.5
sp22	sp23	PIO/TIMER/IDMA inputs	8	8	8	8	0.5	0.5	0.5	0.5

1 Input specifications are measured from the 50% level of the signal to the 50% level of the rising edge of CLKIN. Timings are measured at the pin.

NOTE

Although the specifications generally reference the rising edge of the clock, the following AC timing diagrams also apply when the falling edge is the active edge.

This figure shows the FCC internal clock.

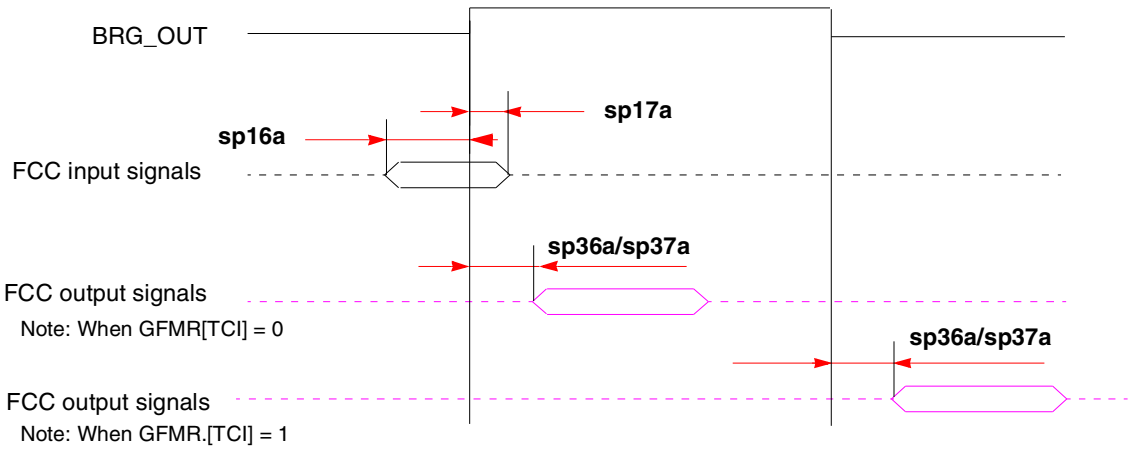
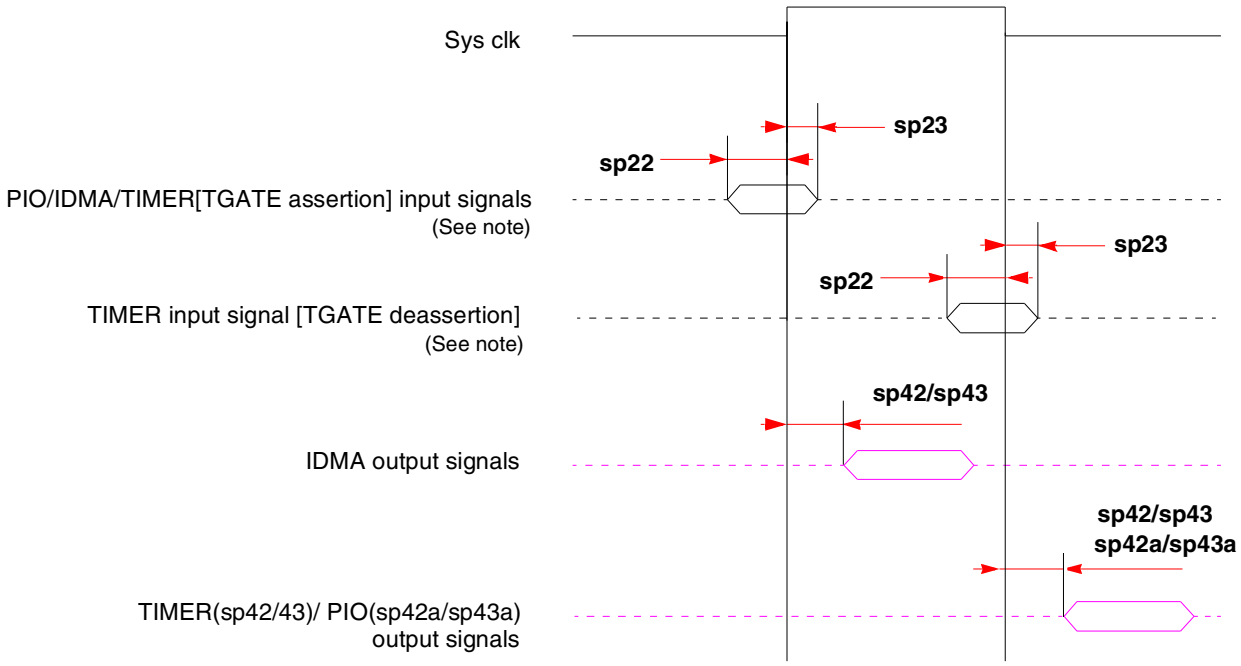


Figure 3. FCC Internal Clock Diagram

This figure shows PIO and timer signals.



Note: TGATE is asserted on the rising edge of the clock; it is deasserted on the falling edge.

Figure 8. PIO and Timer Signal Diagram

6.2 SIU AC Characteristics

This table lists SIU input characteristics.

NOTE: CLKIN Jitter and Duty Cycle

The CLKIN input to the SoC should not exceed +/– 150 psec of jitter (peak-to-peak). This represents total input jitter—the combination of short term (peak-to-peak) and long term (cumulative). The duty cycle of CLKIN should not exceed the ratio of 40:60.

NOTE: Spread Spectrum Clocking

Spread spectrum clocking is allowed with 1% input frequency down-spread at maximum 60 KHz modulation rate regardless of input frequency.

NOTE: PCI AC Timing

The SoC meets the timing requirements of *PCI Specification Revision 2.2*. See Section 7, “Clock Configuration Modes,” and “Note: Tval (Output Hold)” to determine if a specific clock configuration is compliant.

NOTE

Activating data pipelining (setting BR*x*[DR] in the memory controller) improves the AC timing.

This figure shows the interaction of several bus signals.

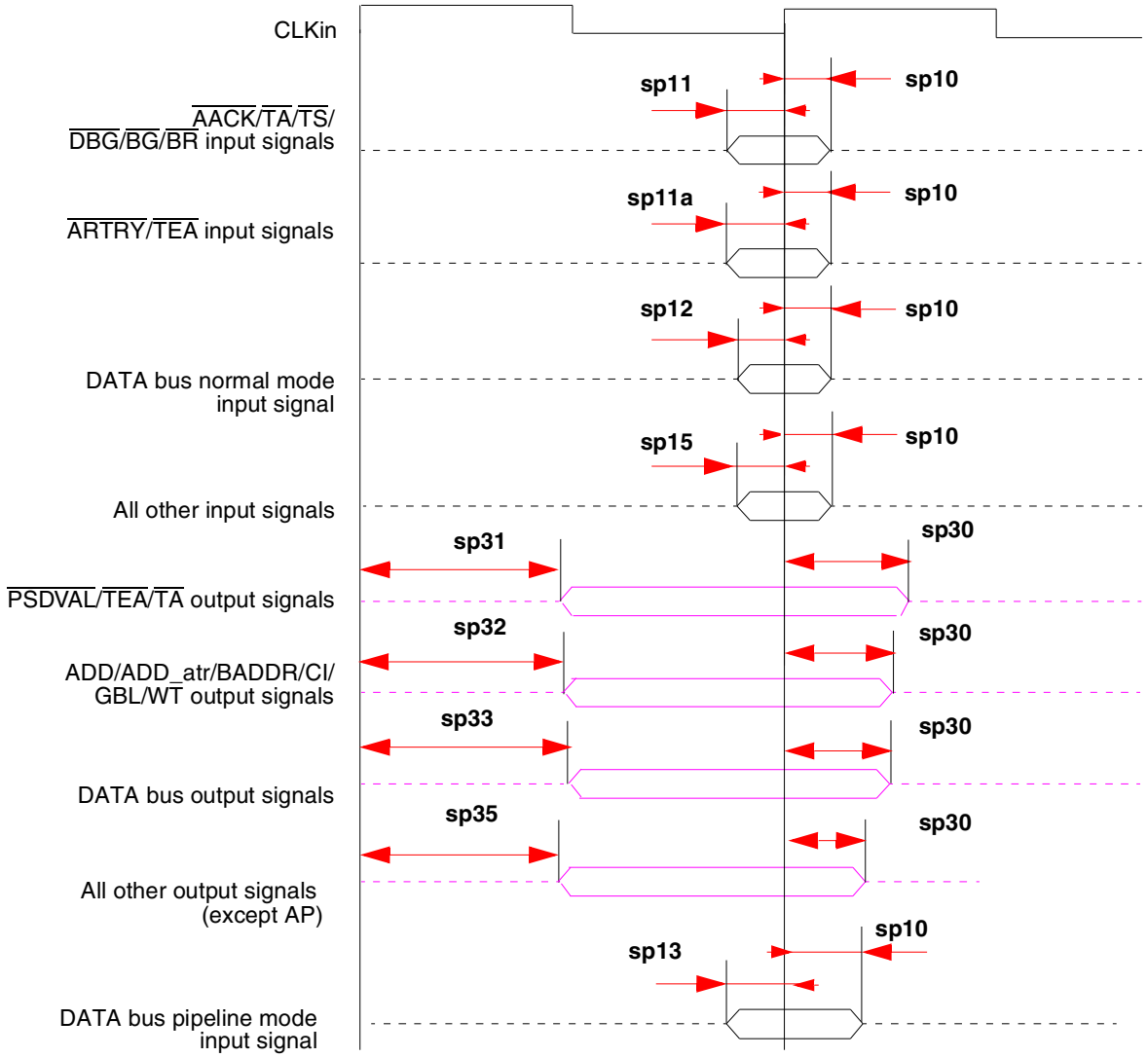


Figure 9. Bus Signals

This figure shows signal behavior in MEMC mode.

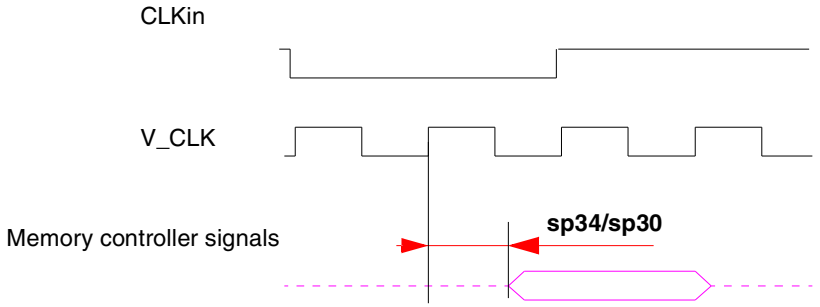


Figure 10. MEMC Mode Diagram

NOTE

Generally, all SoC bus and system output signals are driven from the rising edge of the input clock (CLKin). Memory controller signals, however, trigger on four points within a CLKin cycle. Each cycle is divided by four internal ticks: T1, T2, T3, and T4. T1 always occurs at the rising edge, and T3 at the falling edge, of CLKin. However, the spacing of T2 and T4 depends on the PLL clock ratio selected, as shown in Table 14.

Table 14. Tick Spacing for Memory Controller Signals

PLL Clock Ratio	Tick Spacing (T1 Occurs at the Rising Edge of CLKin)		
	T2	T3	T4
1:2, 1:3, 1:4, 1:5, 1:6	1/4 CLKin	1/2 CLKin	3/4 CLKin
1:2.5	3/10 CLKin	1/2 CLKin	8/10 CLKin
1:3.5	4/14 CLKin	1/2 CLKin	11/14 CLKin

This table is a representation of the information in Table 14.

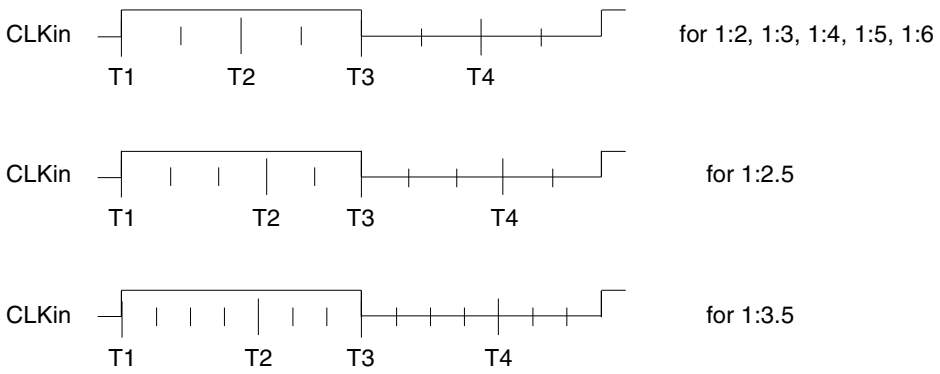


Figure 11. Internal Tick Spacing for Memory Controller Signals

7 Clock Configuration Modes

As shown in this table, the clocking mode is set according to two sources:

- PCI_CFG[0]— An input signal. Also defined as "$\overline{\text{PCI\_HOST\_EN}}$." See Chapter 6, "External Signals," and Chapter 9, "PCI Bridge," in the SoC reference manual.
- PCI_MODCK—Bit 27 in the Hard Reset Configuration Word. See Chapter 5, "Reset," in the SoC reference manual.

Table 16. SoC Clocking Modes

Pins		Clocking Mode	PCI Clock Frequency Range (MHz)	Reference
PCI_CFG[0][1]	PCI_MODCK[2]			
0	0	PCI host	50–66	Table 17
0	1		25–50	Table 18
1	0	PCI agent	50–66	Table 19
1	1		25–50	Table 20

1 PCI_HOST_EN
2 Determines PCI clock frequency range.

Within each mode, the configuration of bus, core, PCI, and CPM frequencies is determined by seven bits during the power-on reset—three hardware configuration pins (MODCK[1–3]) and four bits from hardware configuration word[28–31] (MODCK_H). Both the PLLs and the dividers are set according to the selected clock operation mode as described in the following sections.

NOTE

Clock configurations change only after $\overline{\text{PORESET}}$ is asserted.

NOTE: Tval (Output Hold)

The minimum Tval = 2 ns when PCI_MODCK = 1, and the minimum Tval = 1 ns when PCI_MODCK = 0. Therefore, designers should use clock configurations that fit this condition to achieve PCI-compliant AC timing.

7.1 PCI Host Mode

These tables show configurations for PCI host mode. The frequency values listed are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user's device. Note that in PCI host mode the input clock is the bus clock.

Table 17. Clock Configurations for PCI Host Mode (PCI_MODCK=0)[1,2] (continued)

Mode[3]	Bus Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		PCI Division Factor[6]	PCI Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
1011_100	80.0	106.7	2.5	200.0	266.6	4	320.0	426.6	4	50.0	66.7
1011_101	80.0	106.7	2.5	200.0	266.6	4.5	360.0	480.0	4	50.0	66.7
1101_000	100.0	133.3	2.5	250.0	333.3	3	300.0	400.0	5	50.0	66.7
1101_001	100.0	133.3	2.5	250.0	333.3	3.5	350.0	466.6	5	50.0	66.7
1101_010	100.0	133.3	2.5	250.0	333.3	4	400.0	533.3	5	50.0	66.7
1101_011	100.0	133.3	2.5	250.0	333.3	4.5	450.0	599.9	5	50.0	66.7
1101_100	100.0	133.3	2.5	250.0	333.3	5	500.0	666.6	5	50.0	66.7
1101_101	125.0	166.7	2	250.0	333.3	3	375.0	500.0	5	50.0	66.7
1101_110	125.0	166.7	2	250.0	333.3	4	500.0	666.6	5	50.0	66.7
1110_000	100.0	133.3	3	300.0	400.0	3.5	350.0	466.6	6	50.0	66.7
1110_001	100.0	133.3	3	300.0	400.0	4	400.0	533.3	6	50.0	66.7
1110_010	100.0	133.3	3	300.0	400.0	4.5	450.0	599.9	6	50.0	66.7
1110_011	100.0	133.3	3	300.0	400.0	5	500.0	666.6	6	50.0	66.7
1110_100	100.0	133.3	3	300.0	400.0	5.5	550.0	733.3	6	50.0	66.7
1100_000	Reserved										
1100_001	Reserved										
1100_010	Reserved										

1 The “low” values are the minimum allowable frequencies for a given clock mode. The minimum bus frequency in a table entry guarantees only the required minimum CPU operating frequency. The “high” values are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user’s device. The minimum CPU frequency is 150 MHz for commercial temperature devices and 175 MHz for extended temperature devices. The minimum CPM frequency is 120 MHz.

2 PCI_MODCK determines the PCI clock frequency range. SeeTable 18 for lower range configurations.

3 MODCK_H = hard reset configuration word [28–31] (see Section 5.4 in the SoC reference manual). MODCK[1-3] = three hardware configuration pins.

4 CPM multiplication factor = CPM clock/bus clock

5 CPU multiplication factor = Core PLL multiplication factor

6 CPM_CLK/PCI_CLK ratio. When PCI_MODCK = 0, the ratio of CPM_CLK/PCI_CLK should be calculated from SCCR[PCIDF] as follows:
CPM_CLK/PCI_CLK = (PCIDF + 1) / 2.

6 CPM_CLK/PCI_CLK ratio. When PCI_MODCK = 1, the ratio of CPM_CLK/PCI_CLK should be calculated from PCIDF as follows:
PCIDF = 3 > CPM_CLK/PCI_CLK = 4
PCIDF = 5 > CPM_CLK/PCI_CLK = 6
PCIDF = 7 > CPM_CLK/PCI_CLK = 8
PCIDF = 9 > CPM_CLK/PCI_CLK = 5
PCIDF = B > CPM_CLK/PCI_CLK = 6

7.2 PCI Agent Mode

These tables show configurations for PCI agent mode. The frequency values listed are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user's device. Note that in PCI agent mode the input clock is PCI clock.

Table 19. Clock Configurations for PCI Agent Mode (PCI_MODCK=0)[1,2]

Mode[3]	PCI Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
Default Modes (MODCK_H=0000)											
0000_000	60.0	66.7	2	120.0	133.3	2.5	150.0	166.7	2	60.0	66.7
0000_001	50.0	66.7	2	100.0	133.3	3	150.0	200.0	2	50.0	66.7
0000_010	50.0	66.7	3	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0000_011	50.0	66.7	3	150.0	200.0	4	200.0	266.6	3	50.0	66.7
0000_100	50.0	66.7	3	150.0	200.0	3	180.0	240.0	2.5	60.0	80.0
0000_101	50.0	66.7	3	150.0	200.0	3.5	210.0	280.0	2.5	60.0	80.0
0000_110	50.0	66.7	4	200.0	266.6	3.5	233.3	311.1	3	66.7	88.9
0000_111	50.0	66.7	4	200.0	266.6	3	240.0	320.0	2.5	80.0	106.7
Full Configuration Modes											
0001_001	60.0	66.7	2	120.0	133.3	5	150.0	166.7	4	30.0	33.3
0001_010	50.0	66.7	2	100.0	133.3	6	150.0	200.0	4	25.0	33.3
0001_011	50.0	66.7	2	100.0	133.3	7	175.0	233.3	4	25.0	33.3
0001_100	50.0	66.7	2	100.0	133.3	8	200.0	266.6	4	25.0	33.3
0010_001	50.0	66.7	3	150.0	200.0	3	180.0	240.0	2.5	60.0	80.0
0010_010	50.0	66.7	3	150.0	200.0	3.5	210.0	280.0	2.5	60.0	80.0
0010_011	50.0	66.7	3	150.0	200.0	4	240.0	320.0	2.5	60.0	80.0
0010_100	50.0	66.7	3	150.0	200.0	4.5	270.0	360.0	2.5	60.0	80.0

Table 19. Clock Configurations for PCI Agent Mode (PCI_MODCK=0)[1,2] (continued)

Mode[3]	PCI Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
1100_101	50.0	66.7	6	300.0	400.0	4	400.0	533.3	3	100.0	133.3
1100_110	50.0	66.7	6	300.0	400.0	4.5	450.0	599.9	3	100.0	133.3
1100_111	50.0	66.7	6	300.0	400.0	5	500.0	666.6	3	100.0	133.3
1101_000	50.0	66.7	6	300.0	400.0	5.5	550.0	733.3	3	100.0	133.3
1101_001	50.0	66.7	6	300.0	400.0	3.5	420.0	559.9	2.5	120.0	160.0
1101_010	50.0	66.7	6	300.0	400.0	4	480.0	639.9	2.5	120.0	160.0
1101_011	50.0	66.7	6	300.0	400.0	4.5	540.0	719.9	2.5	120.0	160.0
1101_100	50.0	66.7	6	300.0	400.0	5	600.0	799.9	2.5	120.0	160.0
1110_000	50.0	66.7	5	250.0	333.3	2.5	312.5	416.6	2	125.0	166.7
1110_001	50.0	66.7	5	250.0	333.3	3	375.0	500.0	2	125.0	166.7
1110_010	50.0	66.7	5	250.0	333.3	3.5	437.5	583.3	2	125.0	166.7
1110_011	50.0	66.7	5	250.0	333.3	4	500.0	666.6	2	125.0	166.7
1110_100	50.0	66.7	5	250.0	333.3	4	333.3	444.4	3	83.3	111.1
1110_101	50.0	66.7	5	250.0	333.3	4.5	375.0	500.0	3	83.3	111.1
1110_110	50.0	66.7	5	250.0	333.3	5	416.7	555.5	3	83.3	111.1
1110_111	50.0	66.7	5	250.0	333.3	5.5	458.3	611.1	3	83.3	111.1
1100_000	Reserved										
1100_001	Reserved										
1100_010	Reserved										

1 The “low” values are the minimum allowable frequencies for a given clock mode. The minimum bus frequency in a table entry guarantees only the required minimum CPU operating frequency. The “high” values are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user’s device. The minimum CPU frequency is 150 MHz for commercial temperature devices and 175 MHz for extended temperature devices. The minimum CPM frequency is 120 MHz.

2 PCI_MODCK determines the PCI clock frequency range. See Table 20 for lower range configurations.

3 MODCK_H = hard reset configuration word [28–31] (see Section 5.4 in the SoC reference manual). MODCK[1-3] = three hardware configuration pins.

4 CPM multiplication factor = CPM clock/bus clock

5 CPU multiplication factor = Core PLL multiplication factor

Table 20. Clock Configurations for PCI Agent Mode (PCI_MODCK=1)[1,2]

Mode[3]	PCI Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
Default Modes (MODCK_H=0000)											
0000_000	30.0	50.0	4	120.0	200.0	2.5	150.0	250.0	2	60.0	100.0
0000_001	25.0	50.0	4	100.0	200.0	3	150.0	300.0	2	50.0	100.0
0000_010	25.0	50.0	6	150.0	300.0	3	150.0	300.0	3	50.0	100.0
0000_011	25.0	50.0	6	150.0	300.0	4	200.0	400.0	3	50.0	100.0
0000_100	25.0	50.0	6	150.0	300.0	3	180.0	360.0	2.5	60.0	120.0
0000_101	25.0	50.0	6	150.0	300.0	3.5	210.0	420.0	2.5	60.0	120.0
0000_110	25.0	50.0	8	200.0	400.0	3.5	233.3	466.7	3	66.7	133.3
0000_111	25.0	50.0	8	200.0	400.0	3	240.0	480.0	2.5	80.0	160.0
Full Configuration Modes											
0001_001	30.0	50.0	4	120.0	200.0	5	150.0	250.0	4	30.0	50.0
0001_010	25.0	50.0	4	100.0	200.0	6	150.0	300.0	4	25.0	50.0
0001_011	25.0	50.0	4	100.0	200.0	7	175.0	350.0	4	25.0	50.0
0001_100	25.0	50.0	4	100.0	200.0	8	200.0	400.0	4	25.0	50.0
0010_001	25.0	50.0	6	150.0	300.0	3	180.0	360.0	2.5	60.0	120.0
0010_010	25.0	50.0	6	150.0	300.0	3.5	210.0	420.0	2.5	60.0	120.0
0010_011	25.0	50.0	6	150.0	300.0	4	240.0	480.0	2.5	60.0	120.0
0010_100	25.0	50.0	6	150.0	300.0	4.5	270.0	540.0	2.5	60.0	120.0
0011_000	Reserved										
0011_001	37.5	50.0	4	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0011_010	32.1	50.0	4	128.6	200.0	3.5	150.0	233.3	3	42.9	66.7
0011_011	28.1	50.0	4	112.5	200.0	4	150.0	266.7	3	37.5	66.7
0011_100	25.0	50.0	4	100.0	200.0	4.5	150.0	300.0	3	33.3	66.7
0100_000	Reserved										
0100_001	25.0	50.0	6	150.0	300.0	3	150.0	300.0	3	50.0	100.0
0100_010	25.0	50.0	6	150.0	300.0	3.5	175.0	350.0	3	50.0	100.0
0100_011	25.0	50.0	6	150.0	300.0	4	200.0	400.0	3	50.0	100.0

Table 20. Clock Configurations for PCI Agent Mode (PCI_MODCK=1)[1,2] (continued)

Mode[3]	PCI Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
1110_000	25.0	50.0	5	125.0	250.0	2.5	156.3	312.5	2	62.5	125.0
1110_001	25.0	50.0	5	125.0	250.0	3	187.5	375.0	2	62.5	125.0
1110_010	28.6	50.0	5	142.9	250.0	3.5	250.0	437.5	2	71.4	125.0
1110_011	25.0	50.0	5	125.0	250.0	4	250.0	500.0	2	62.5	125.0
1110_100	25.0	50.0	5	125.0	250.0	4	166.7	333.3	3	41.7	83.3
1110_101	25.0	50.0	5	125.0	250.0	4.5	187.5	375.0	3	41.7	83.3
1110_110	25.0	50.0	5	125.0	250.0	5	208.3	416.7	3	41.7	83.3
1110_111	25.0	50.0	5	125.0	250.0	5.5	229.2	458.3	3	41.7	83.3
1100_000	Reserved										
1100_001	Reserved										
1100_010	Reserved										

1 The “low” values are the minimum allowable frequencies for a given clock mode. The minimum bus frequency in a table entry guarantees only the required minimum CPU operating frequency. The “high” values are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user’s device. The minimum CPU frequency is 150 MHz for commercial temperature devices and 175 MHz for extended temperature devices. The minimum CPM frequency is 120 MHz.

2 PCI_MODCK determines the PCI clock frequency range. See Table 19 for higher range configurations.

3 MODCK_H = hard reset configuration word [28–31] (see Section 5.4 in the SoC reference manual). MODCK[1-3] = three hardware configuration pins.

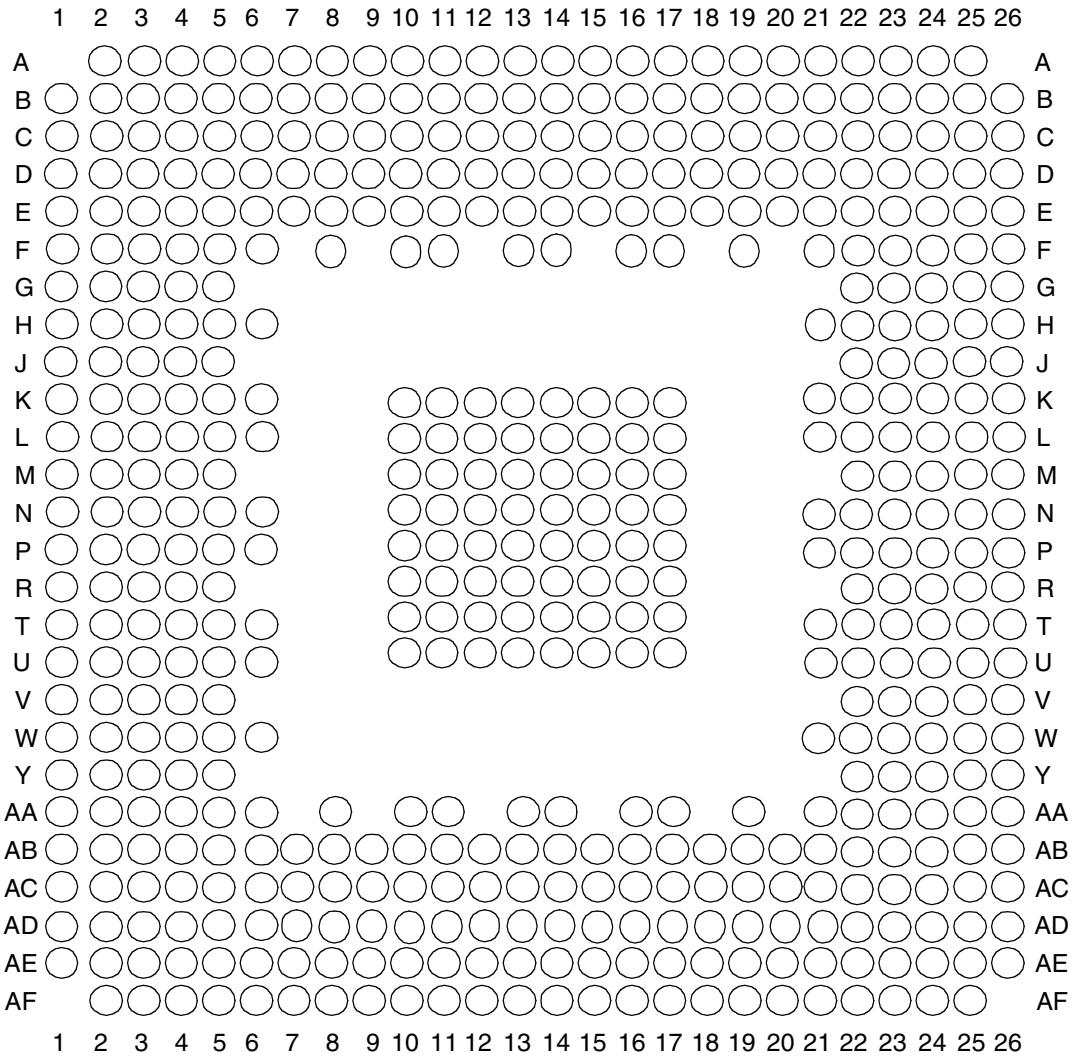
4 CPM multiplication factor = CPM clock/bus clock

5 CPU multiplication factor = Core PLL multiplication factor

8 Pinout

This figure and table show the pin assignments and pinout for the 516 PBGA package.

This figure shows the pinout of the 516 PBGA package as viewed from the top surface.



Not to Scale

Figure 12. Pinout of the 516 PBGA Package (View from Top)

This table lists the pins of the MPC8272. Note that the pins in the “MPC8272/8271 Only” column relate to Utopia functionality.

Table 21. Pinout

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
$\overline{BR}$		A19
$\overline{BG}$/$\overline{IRQ6}$		D2
$\overline{ABB}$/$\overline{IRQ2}$		C1

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
D46		H4
D47		F2
D48		AB1
D49		U4
D50		U1
D51		R3
D52		N3
D53		K2
D54		H5
D55		F4
D56		AA3
D57		U5
D58		U2
D59		P5
D60		M3
D61		K4
D62		H3
D63		E1
$\overline{\text{IRQ3}}$/CKSTP_OUT/EXT_BR3		B16
$\overline{\text{IRQ4}}$/CORE_SRESET/EXT_BG3		C15
$\overline{\text{IRQ5}}$/TBEN/EXT_DBG3/$\overline{\text{CINT}}$		Y4
$\overline{\text{PSDVAL}}$		C19
$\overline{\text{TA}}$		AA4
$\overline{\text{TEA}}$		AB6
$\overline{\text{GBL}}$/$\overline{\text{IRQ1}}$		D15
$\overline{\text{CI}}$/BADDR29/$\overline{\text{IRQ2}}$		D16
$\overline{\text{WT}}$/BADDR30/$\overline{\text{IRQ3}}$		C16
BADDR31/$\overline{\text{IRQ5}}$/$\overline{\text{CINT}}$		E17
$\overline{\text{CPU\_BR}}$/$\overline{\text{INT\_OUT}}$		B20
$\overline{\text{CS0}}$		AE6
$\overline{\text{CS1}}$		AD7

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
$\overline{\text{PCI\_IRDY}}$		AF15
$\overline{\text{PCI\_STOP}}$		AE15
$\overline{\text{PCI\_DEVSEL}}$		AE14
PCI_IDSEL		AC17
$\overline{\text{PCI\_PERR}}$		AD14
$\overline{\text{PCI\_SERR}}$		AD13
$\overline{\text{PCI\_REQ0}}$		AE20
$\overline{\text{PCI\_REQ1}}$/CPCI_HS_ES		AF14
$\overline{\text{PCI\_GNT0}}$		AD20
$\overline{\text{PCI\_GNT1}}$/CPCI_HS_LED		AE13
$\overline{\text{PCI\_GNT2}}$/$\overline{\text{CPCI\_HS\_ENUM}}$		AF21
$\overline{\text{PCI\_RST}}$		AF22
$\overline{\text{PCI\_INTA}}$		AE21
$\overline{\text{PCI\_REQ2}}$		AB14
DLLOUT		AC22
PCI_AD0		AF7
PCI_AD1		AE10
PCI_AD2		AB10
PCI_AD3		AD10
PCI_AD4		AE9
PCI_AD5		AF8
PCI_AD6		AC10
PCI_AD7		AE11
PCI_AD8		AB11
PCI_AD9		AF10
PCI_AD10		AF9
PCI_AD11		AB12
PCI_AD12		AC12
PCI_AD13		AD12
PCI_AD14		AF11
PCI_AD15		AB13

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	**MPC8272/MPC8271 Only**	
MODCK1/$\overline{\text{RSRV}}$/TC0/BNKSEL0		A20
MODCK2/CSE0/TC1/BNKSEL1		C20
MODCK3/CSE1/TC2/BNKSEL2		A21
CLKIN1		D21
PA8/SMRXD2		AF25[3]
PA9/SMTXD2		AA22[3]
PA10/MSNUM5	FCC1_UT_RXD0	AB23[3]
PA11/MSNUM4	FCC1_UT_RXD1	AD26[3]
PA12/MSNUM3	FCC1_UT_RXD2	AD25[3]
PA13/MSNUM2	FCC1_UT_RXD3	AA24[3]
PA14/FCC1_MII_HDLC_RXD3	FCC1_UT_RXD4	W22[3]
PA15/FCC1_MII_HDLC_RXD2	FCC1_UT_RXD5	Y24[3]
PA16/FCC1_MII_HDLC_RXD1	FCC1_UT_RXD6	T22[3]
PA17/FCC1_MII_HDLC_RXD0/ FCC1_MII_TRAN_RXD/FCC1_RMII_RXD0	FCC1_UT_RXD7	W26[3]
PA18/FCC1_MII_HDLC_TXD0/FCC1_MII_TRAN_TXD/ FCC1_RMII_TXD0	FCC1_UT_TXD7	V26[3]
PA19/FCC1_MII_HDLC_TXD1/FCC1_RMII_TXD1	FCC1_UT_TXD6	R23[3]
PA20/FCC1_MII_HDLC_TXD2	FCC1_UT_TXD5	P25[3]
PA21/FCC1_MII_HDLC_TXD3	FCC1_UT_TXD4	N22[3]
PA22	FCC1_UT_TXD3	N26[3]
PA23	FCC1_UT_TXD2	N23[3]
PA24/MSNUM1	FCC1_UT_TXD1	H26[3]
PA25/MSNUM0	FCC1_UT_TXD0	G25[3]
PA26/FCC1_MII_RMIIRX_ER	FCC1_UT_RXCLAV	L22[3]
PA27/FCC1_MII_RX_DV/FCC1_RMII_CRS_DV	FCC1_UT_RXSOC	G24[3]
PA28/FCC1_MII_RMII_TX_EN	FCC1_UT_RXENB	G23[3]
PA29/FCC1_MII_TX_ER	$\overline{\text{FCC1\_UT\_TXSOC}}$	B26[3]
PA30/FCC1_MII_CRS/$\overline{\text{FCC1\_RTS}}$	FCC1_UT_TXCLAV	A25[3]

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
PC17/CLK15/BRGO8/$\overline{\text{DONE2}}$		T26[3]
PC18/CLK14/$\overline{\text{TGATE2}}$		R26[3]
PC19/CLK13/BRGO7/$\overline{\text{TGATE1}}$		P24[3]
PC20/CLK12/$\overline{\text{USBOE}}$		L26[3]
PC21/CLK11/BRGO6/CP_INT		L24[3]
PC22/CLK10/$\overline{\text{DONE3}}$	FCC1_UT_TXPRTY	L23[3]
PC23/CLK9/BRGO5/$\overline{\text{DACK3}}$/$\overline{\text{CD1}}$		K24[3]
PC24/CLK8/TIN3/$\overline{\text{TOUT4}}$/DREQ2/BRGO1		K23[3]
PC25/CLK7/BRGO4/$\overline{\text{DACK2}}$/SPISEL		F26[3]
PC26/CLK6/$\overline{\text{TOUT3}}$/TMCLK		H23[3]
PC27/CLK5/BRGO3/$\overline{\text{TOUT1}}$	FCC1_UT_RXPRTY	K22[3]
PC28/CLK4/TIN1/$\overline{\text{TOUT2}}$/SPICLK		D25[3]
PC29/CLK3/TIN2/BRGO2/$\overline{\text{CTS1}}$		F24[3]
PD7/SMSYN2	FCC1_UT_TXADDR3	AB21[3]
PD14/I2CSCL		AC26[3]
PD15/I2CSDA		Y23[3]
PD16/SPIMISO	FCC1_UT_TXPRTY	AA25[3]
PD17/BRGO2/SPIMOSI	FCC1_UT_RXPRTY	Y26[3]
PD18/SPICLK	FCC1_UT_RXADDR4	W25[3]
PD19/SPISEL/BRGO1	FCC1_UT_TXADDR4	V25[3]
PD20/$\overline{\text{RTS4}}$/L1RSYNCA2		R24[3]
PD21/TXD4/L1RXD0A2		P23[3]
PD22/RXD4/L1TXD0A2		N25[3]
PD23/$\overline{\text{RTS3}}$/USB_TP		K26[3]
PD24/TXD3/USB_TN		K25[3]
PD25/RXD3/USB_RXD		J25[3]
PD29/$\overline{\text{RTS1}}$	FCC1_UT_RXADDR3	C26[3]
PD30/TXD1		E24[3]
PD31/RXD1		B25[3]
VCCSYN		C18
VCCSYN1		K6

10 Ordering Information

This figure provides an example of the Freescale part numbering nomenclature for the SoC. In addition to the processor frequency, the part numbering scheme also consists of a part modifier that indicates any enhancement(s) in the part from the original production design. Each part number also contains a revision code that refers to the die mask revision number and is specified in the part numbering scheme for identification purposes only. For more information, contact your local Freescale sales office.

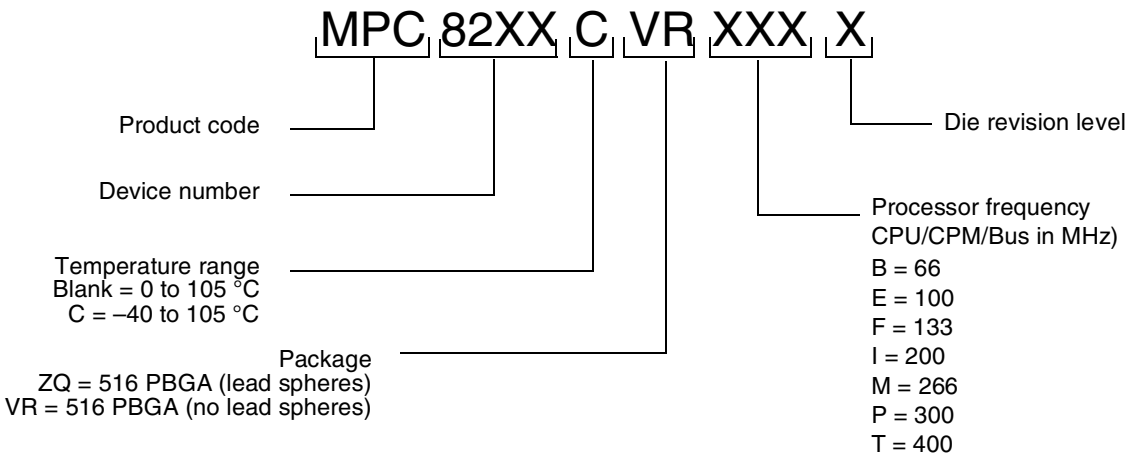


Figure 15. Freescale Part Number Key

11 Document Revision History

This table summarizes changes to this document.

Table 23. Document Revision History

Revision	Date	Substantive Changes
3	09/2011	In Figure 15, “Freescale Part Number Key,” added speed decoding information below processor frequency information.
2	12/2008	• Modified Figure 5, “SCC/SMC/SPI/I2C External Clock Diagram,” and added second section of figure notes. • In Table 12, modified “Data bus in pipeline mode” row and showed 66 MHz as “N/A.” • In Section 10, “Ordering Information,” added “F = 133” to CPU/CPM/Bus Frequency. • Added footnote concerning CPM_CLK/PCI_CLK ratio to column “PCI Division Factor” in Table 17, “Clock Configurations for PCI Host Mode (PCI_MODCK=0),” and Table 18, “Clock Configurations for PCI Host Mode (PCI_MODCK=1),.” • Removed overbar from DLL_ENABLE in Table 21, “Pinout.”
1.5	12/2006	• Section 6, “AC Electrical Characteristics,” removed deratings statement and clarified AC timing descriptions.
1.4	05/2006	• Added row for 133 MHz configurations to Table 8.
1.3	02/2006	• Inserted Section 6.3, “JTAG Timings.”

Table 23. Document Revision History (continued)

Revision	Date	Substantive Changes
0.2	12/2003	• Table 1: New • Table 2: New • Table 4: Modification of VDD and VCCSYN to 1.45–1.60 V • Table 8: Addition of note 2 regarding TRST and PORESET (see V_{IH} row of Table 8) • Table 8 and Table 21: Addition of muxed signals CPCI_HS_ES to PCI_REQ1 (AF14) CPCI_HS_LED to PCI_GNT1 (AE13) CPCI_HS_ENUM to PCI_GNT2 (AF21) • Table 8 and Table 21: Modification of PCI signal names for consistency with PCI signal names on other PowerQUICC II devices: PCI_CFG0 (PCI_HOST_EN) (AC21) PCI_CFG1 (PCI_ARB_EN) (AE22) PCI_CFG2 (DLL_ENABLE) (AE23) PCI_PAR (AF12) PCI_FRAME (AD15) PCI_TRDY(AF16) PCI_IRDY (AF15) PCI_STOP (AE15) DEVSEL (AE14) PCI_IDSEL (AC17) PCI_PERR (AD14) PCI_SERR (AD13) PCI_REQ0–2 (AAE20, AF14, AB14) PCI_GNT0–2 (AD20, AE13, AF21) PCI_RST (AF22) PCI_INTA (AE21) PCI_C0-3 (AE12, AF13, AC15, AE18) PCI_AD0-31 • Table 8 and Table 21: Corrected assertion level (added "‾") PCI_HOST_EN (AC21) and PCI_ARB_EN (AE22) • Table 7: Addition of $R_{\theta JT}$ and note 4 • Sections 4.1–4.5 and 4.7 on thermal characteristics: New • Section 7, "Clock Configuration Modes": Modification to first paragraph. Note that PCI_MODCK is a bit in the Hard Reset Configuration Word. It is not an input signal as it is in the MPC8280 Family and MPC8260 Family. • Addition of "Note: Temperature Reflow for the VR Package" on page 56 • Table 21: Addition of note 2 to TRST (E21) and PORESET (C24) • Table 21: Removal of Thermal0 (D19) and Thermal1(J3). These pins are now "No connects." Note 4 unchanged. • Table 21: Removal of Spare0 (AD24). This pin is now a "No connect." Note 5 unchanged. • Table 21: Addition of PCI_MODE (AD22). This pin was previously listed as "Ground." Addition of note 1.
0.1	9/2003	• Addition of the MPC8271 and the MPC8247 (these devices do not have a security engine) • Table 8: Addition of note 2 to V_{IH} • Table 8: Changed I_{OL} for 60x signals to 6.0 mA • Modification of note 1 for Table 17, Table 18, Table 19, and Table 20 • Table 21: Addition of ball AD9 to GND. In rev 0 of this document, AD8 was listed as assigned to both CS5 and GND. AD8 is only assigned to CS5. • Table 21: Addition of note 4 to Thermal0 (D19) and Thermal1(J3) • Addition of ZQ package code to Figure 15
0	5/2003	NDA release